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Details

Betuns	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf873-04i-sp

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Pin Name	DIP Pin#	PLCC Pin#	QFP Pin#	l/O/P Type	Buffer Type	Description
						PORTC is a bi-directional I/O port.
RC0/T1OSO/T1CKI	15	16	32	I/O	ST	RC0 can also be the Timer1 oscillator output or a Timer1 clock input.
RC1/T1OSI/CCP2	16	18	35	I/O	ST	RC1 can also be the Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output.
RC2/CCP1	17	19	36	I/O	ST	RC2 can also be the Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	18	20	37	I/O	ST	RC3 can also be the synchronous serial clock input/ output for both SPI and I ² C modes.
RC4/SDI/SDA	23	25	42	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	24	26	43	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK	25	27	44	I/O	ST	RC6 can also be the USART Asynchronous Transmi or Synchronous Clock.
RC7/RX/DT	26	29	1	I/O	ST	RC7 can also be the USART Asynchronous Receive or Synchronous Data.
						PORTD is a bi-directional I/O port or parallel slave port when interfacing to a microprocessor bus.
RD0/PSP0	19	21	38	I/O	ST/TTL ⁽³⁾	
RD1/PSP1	20	22	39	I/O	ST/TTL ⁽³⁾	
RD2/PSP2	21	23	40	I/O	ST/TTL ⁽³⁾	
RD3/PSP3	22	24	41	I/O	ST/TTL ⁽³⁾	
RD4/PSP4	27	30	2	I/O	ST/TTL ⁽³⁾	
RD5/PSP5	28	31	3	I/O	ST/TTL ⁽³⁾	
RD6/PSP6	29	32	4	I/O	ST/TTL ⁽³⁾	
RD7/PSP7	30	33	5	I/O	ST/TTL ⁽³⁾	
						PORTE is a bi-directional I/O port.
RE0/RD/AN5	8	9	25	I/O	ST/TTL ⁽³⁾	RE0 can also be read control for the parallel slave port, or analog input5.
RE1/WR/AN6	9	10	26	I/O	ST/TTL ⁽³⁾	RE1 can also be write control for the parallel slave port, or analog input6.
RE2/CS/AN7	10	11	27	I/O	ST/TTL ⁽³⁾	RE2 can also be select control for the parallel slave port, or analog input7.
Vss	12,31	13,34	6,29	Р	_	Ground reference for logic and I/O pins.
Vdd	11,32	12,35	7,28	Р	_	Positive supply for logic and I/O pins.
NC	-	1,17,28, 40	12,13, 33,34		—	These pins are not internally connected. These pins should be left unconnected.
Legend: I = input	0 = 0 — = N	utput lot used		I/O = inp TTL = T	out/output TL input	P = power ST = Schmitt Trigger input

TABLE 1-2: PIC16F874 AND PIC16F877 PINOUT DESCRIPTION (CONTINUED)

Note 1: This buffer is a Schmitt Trigger input when configured as an external interrupt.

2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

3: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

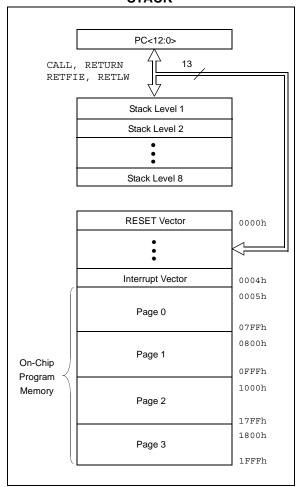
4: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.

2.0 MEMORY ORGANIZATION

There are three memory blocks in each of the PIC16F87X MCUs. The Program Memory and Data Memory have separate buses so that concurrent access can occur and is detailed in this section. The EEPROM data memory block is detailed in Section 4.0.

Additional information on device memory may be found in the PIC[®] MCU Mid-Range Reference Manual, (DS33023).

FIGURE 2-1: PIC16F877/876 PROGRAM MEMORY MAP AND STACK

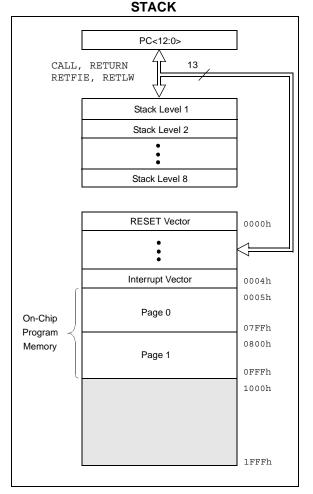


2.1 **Program Memory Organization**

The PIC16F87X devices have a 13-bit program counter capable of addressing an $8K \times 14$ program memory space. The PIC16F877/876 devices have $8K \times 14$ words of FLASH program memory, and the PIC16F873/874 devices have $4K \times 14$. Accessing a location above the physically implemented address will cause a wraparound.

The RESET vector is at 0000h and the interrupt vector is at 0004h.

FIGURE 2-2: PIC16F874/873 PROGRAM MEMORY MAP AND



	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	
	bit 7							bit 0	
bit 7	GCEN : General Call Enable bit (In I ² C Slave mode only) 1 = Enable interrupt when a general call address (0000h) is received in the SSPSR 0 = General call address disabled								
bit 6	ACKSTAT	Acknowledg	e Status bit	(In I ² C Maste	er mode onl	у)			
	1 = Acknow	<u>Transmit mod</u> wledge was n wledge was re	ot received						
bit 5	ACKDT: A	cknowledge [Data bit (In I ⁴	² C Master m	ode only)				
	Value that end of a re	knowledge		the user initi	ates an Ack	nowledge s	equence at	the	
bit 4	ACKEN: A	cknowledge \$	Sequence E	nable bit (In	I ² C Master	mode only)			
	1 = Initiate Autom	Receive mode Acknowledge atically cleare wledge seque	e sequence ed by hardw		I SCL pins a	and transmit	ACKDT da	ta bit.	
bit 3	RCEN: Re	ceive Enable es Receive mo	bit (In I ² C M	laster mode	only)				
bit 2	PEN: STC	P Condition I	Enable bit (I	n I ² C Master	r mode only)			
	1 = Initiate	ase Control: STOP condit condition idle		and SCL pir	ns. Automat	ically cleare	d by hardwa	are.	
bit 1	1 = Initiate	epeated STAR Repeated ST/ ted START co	ART conditic	on on SDA an				/ hardware.	
bit 0	 0 = Repeated START condition idle SEN: START Condition Enable bit (In I²C Master mode only) 1 = Initiate START condition on SDA and SCL pins. Automatically cleared by hardware. 0 = START condition idle 								
		For bits ACK mode, this bit writes to the \$	may not be	set (no spo					
	Logondi								
	Legend: R = Reada	blo bit	\\/ _ \\/.	itable bit		plemented k	hit road as f	0'	
	K = Keaua		vv = vvi		0 = 0.000		n, reau as	0	

'1' = Bit is set

'0' = Bit is cleared

REGISTER 9-3: SSPCON2: SYNC SERIAL PORT CONTROL REGISTER2 (ADDRESS 91h)

- n = Value at POR

x = Bit is unknown

9.2.3 SLEEP OPERATION

While in SLEEP mode, the I²C module can receive addresses or data. When an address match or complete byte transfer occurs, wake the processor from SLEEP (if the SSP interrupt is enabled).

9.2.4 EFFECTS OF A RESET

A RESET disables the SSP module and terminates the current transfer.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	V <u>alue o</u> n: MCLR, WDT
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
0Dh	PIR2	_	(2)	_	EEIF	BCLIF	_	_	CCP2IF	-r-0 00	-r-0 00
8Dh	PIE2	_	(2)	_	EEIE	BCLIE	_	—	CCP2IE	-r-0 00	-r-0 00
13h	SSPBUF	Synchrono	ous Serial Por	rt Receive I	Buffer/Trar	nsmit Reg	ister			xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
91h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
93h	SSPADD	I ² C Slave	I ² C Slave Address/Master Baud Rate Register							0000 0000	0000 0000
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	0000 0000

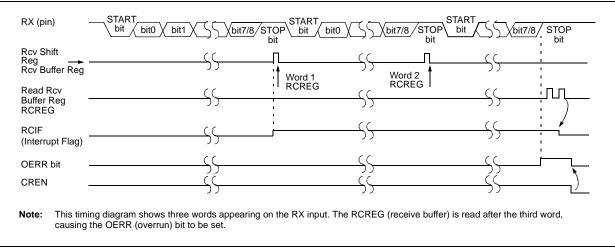
TABLE 9-3: REGISTERS ASSOCIATED WITH I²C OPERATION

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the SSP in I²C mode.

Note 1: These bits are reserved on PIC16F873/876 devices; always maintain these bits clear.

2: These bits are reserved on these devices; always maintain these bits clear.

FIGURE 10-5: ASYNCHRONOUS RECEPTION



When setting up an Asynchronous Reception, follow these steps:

- 1. Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH (Section 10.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, then set enable bit RCIE.
- 4. If 9-bit reception is desired, then set bit RX9.
- 5. Enable the reception by setting bit CREN.

- Flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE is set.
- 7. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading the RCREG register.
- 9. If any error occurred, clear the error by clearing enable bit CREN.
- 10. If using interrupts, ensure that GIE and PEIE (bits 7 and 6) of the INTCON register are set.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	R0IF	x000 0000x	0000 000u
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
1Ah	RCREG	USART R	leceive Reg	gister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rat	Baud Rate Generator Register							0000 0000	0000 0000

TABLE 10-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception. Note 1: Bits PSPIE and PSPIF are reserved on PIC16F873/876 devices; always maintain these bits clear.

10.3 USART Synchronous Master Mode

In Synchronous Master mode, the data is transmitted in a half-duplex manner (i.e., transmission and reception do not occur at the same time). When transmitting data, the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTA<4>). In addition, enable bit SPEN (RCSTA<7>) is set in order to configure the RC6/TX/CK and RC7/RX/DT I/O pins to CK (clock) and DT (data) lines, respectively. The Master mode indicates that the processor transmits the master clock on the CK line. The Master mode is entered by setting bit CSRC (TXSTA<7>).

10.3.1 USART SYNCHRONOUS MASTER TRANSMISSION

The USART transmitter block diagram is shown in Figure 10-6. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer register TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR is loaded with new data from the TXREG (if available). Once the TXREG register transfers the data to the TSR register (occurs in one Tcycle), the TXREG is empty and interrupt bit TXIF (PIR1<4>) is set. The interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set, regardless of the state of enable bit TXIE and cannot be cleared in software. It will reset only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit TRMT (TXSTA<1>) shows the status of the TSR register. TRMT is a read only bit which is set when the TSR is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty. The TSR is not mapped in data memory, so it is not available to the user.

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data. The first data bit will be shifted out on the next available rising edge of the clock on the CK line. Data out is stable around the falling edge of the synchronous clock (Figure 10-9). The transmission can also be started by first loading the TXREG register and then setting bit TXEN (Figure 10-10). This is advantageous when slow baud rates are selected, since the BRG is kept in RESET when bits TXEN, CREN and SREN are clear. Setting enable bit TXEN will start the BRG, creating a shift clock immediately. Normally, when transmission is first started, the TSR register is empty, so a transfer to the TXREG register will result in an immediate transfer to TSR, resulting in an empty TXREG. Back-to-back transfers are possible.

Clearing enable bit TXEN during a transmission will cause the transmission to be aborted and will reset the transmitter. The DT and CK pins will revert to hiimpedance. If either bit CREN or bit SREN is set during a transmission, the transmission is aborted and the DT pin reverts to a hi-impedance state (for a reception). The CK pin will remain an output if bit CSRC is set (internal clock). The transmitter logic, however, is not reset, although it is disconnected from the pins. In order to reset the transmitter, the user has to clear bit TXEN. If bit SREN is set (to interrupt an on-going transmission and receive a single word), then after the single word is received, bit SREN will be cleared and the serial port will revert back to transmitting, since bit TXEN is still set. The DT line will immediately switch from hiimpedance Receive mode to transmit and start driving. To avoid this, bit TXEN should be cleared.

In order to select 9-bit transmission, the TX9 (TXSTA<6>) bit should be set and the ninth bit should be written to bit TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG can result in an immediate transfer of the data to the TSR register (if the TSR is empty). If the TSR was empty and the TXREG was written before writing the "new" TX9D, the "present" value of bit TX9D is loaded.

Steps to follow when setting up a Synchronous Master Transmission:

- 1. Initialize the SPBRG register for the appropriate baud rate (Section 10.1).
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
- 3. If interrupts are desired, set enable bit TXIE.
- 4. If 9-bit transmission is desired, set bit TX9.
- 5. Enable the transmission by setting bit TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Start transmission by loading data to the TXREG register.
- 8. If using interrupts, ensure that GIE and PEIE (bits 7 and 6) of the INTCON register are set.

TABLE 12-2:CAPACITOR SELECTION FOR
CRYSTAL OSCILLATOR

Osc Type	Crystal Freq.	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF

These values are for design guidance only. See notes following this table.

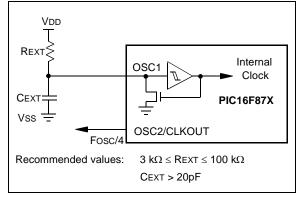
Crystals Used							
32 kHz	Epson C-001R32.768K-A	± 20 PPM					
200 kHz	STD XTL 200.000KHz	± 20 PPM					
1 MHz	ECS ECS-10-13-1	± 50 PPM					
4 MHz	ECS ECS-40-20-1	± 50 PPM					
8 MHz	EPSON CA-301 8.000M-C	± 30 PPM					
20 MHz	EPSON CA-301 20.000M- C	± 30 PPM					

- **Note 1:** Higher capacitance increases the stability of oscillator, but also increases the startup time.
 - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - R_s may be required in HS mode, as well as XT mode, to avoid overdriving crystals with low drive level specification.
 - 4: When migrating from other PIC[®] MCU devices, oscillator performance should be verified.

12.2.3 RC OSCILLATOR

For timing insensitive applications, the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (REXT) and capacitor (CEXT) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low CEXT values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 12-3 shows how the R/C combination is connected to the PIC16F87X.





POR	BOR	то	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on POR
0	x	x	0	Illegal, PD is set on POR
1	0	1	1	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR Reset during normal operation
1	1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP

TABLE 12-4: STATUS BITS AND THEIR SIGNIFICANCE

Legend: x = don't care, u = unchanged

TABLE 12-5: RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	0x
MCLR Reset during normal operation	000h	000u uuuu	uu
MCLR Reset during SLEEP	000h	0001 0uuu	uu
WDT Reset	000h	0000 luuu	uu
WDT Wake-up	PC + 1	uuu0 0uuu	uu
Brown-out Reset	000h	0001 luuu	u0
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul 0uuu	uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0'

Note 1: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

12.12 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run, even if the clock on the OSC1/CLKIN and OSC2/ CLKOUT pins of the device has been stopped, for example, by execution of a SLEEP instruction.

During normal operation, a WDT time-out generates a device RESET (Watchdog Timer Reset). If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation (Watchdog Timer Wake-up). The TO bit in the STATUS register will be cleared upon a Watchdog Timer time-out.

The WDT can be permanently disabled by clearing configuration bit WDTE (Section 12.1).

WDT time-out period values may be found in the Electrical Specifications section under parameter #31. Values for the WDT prescaler (actually a postscaler, but shared with the Timer0 prescaler) may be assigned using the OPTION_REG register.

- Note 1: The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition.
 - 2: When a CLRWDT instruction is executed and the prescaler is assigned to the WDT, the prescaler count will be cleared, but the prescaler assignment is not changed.

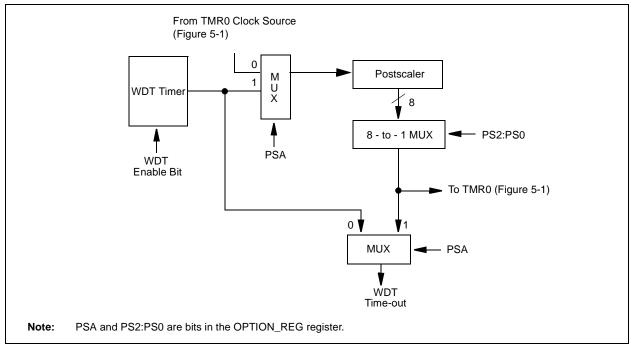


FIGURE 12-10: WATCHDOG TIMER BLOCK DIAGRAM

TABLE 12-7: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
2007h	Config. bits	(1)	BODEN ⁽¹⁾	CP1	CP0	PWRTE ⁽¹⁾	WDTE	FOSC1	FOSC0
81h,181h	OPTION_REG	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0

Legend: Shaded cells are not used by the Watchdog Timer. **Note 1:** See Register 12-1 for operation of these bits.

12.13 Power-down Mode (SLEEP)

Power-down mode is entered by executing a $\ensuremath{\mathtt{SLEEP}}$ instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit (STATUS<3>) is cleared, the TO (STATUS<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD or VSS, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D and disable external clocks. Pull all I/O pins that are hi-impedance inputs, high or low externally, to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should also be considered.

The MCLR pin must be at a logic high level (VIHMC).

12.13.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External RESET input on MCLR pin.
- 2. Watchdog Timer Wake-up (if WDT was enabled).
- 3. Interrupt from INT pin, RB port change or peripheral interrupt.

External MCLR Reset will cause a device RESET. All other events are considered a continuation of program execution and cause a "wake-up". The TO and PD bits in the STATUS register can be used to determine the cause of device RESET. The PD bit, which is set on power-up, is cleared when SLEEP is invoked. The TO bit is cleared if a WDT time-out occurred and caused wake-up.

The following peripheral interrupts can wake the device from SLEEP:

- 1. PSP read or write (PIC16F874/877 only).
- 2. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 3. CCP Capture mode interrupt.
- 4. Special event trigger (Timer1 in Asynchronous mode using an external clock).
- 5. SSP (START/STOP) bit detect interrupt.
- SSP transmit or receive in Slave mode (SPI/I²C).
- 7. USART RX or TX (Synchronous Slave mode).
- 8. A/D conversion (when A/D clock source is RC).
- 9. EEPROM write operation completion

Other peripherals cannot generate interrupts since during SLEEP, no on-chip clocks are present. When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

12.13.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake-up from SLEEP. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the PD bit. If the PD bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

SWAPF	Swap Nibbles in f
Syntax:	[label] SWAPF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	$(f<3:0>) \rightarrow (destination<7:4>), (f<7:4>) \rightarrow (destination<3:0>)$
Status Affected:	None
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed in register 'f'.

XORWF	Exclusive OR W with f					
Syntax:	[<i>label</i>] XORWF f,d					
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$					
Operation:	(W) .XOR. (f) \rightarrow (destination)					
Status Affected:	Z					
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.					

XORLW	Exclusive OR Literal with W				
Syntax:	[<i>label</i>] XORLW k				
Operands:	$0 \leq k \leq 255$				
Operation:	(W) .XOR. $k \rightarrow (W)$				
Status Affected:	Z				
Description:	The contents of the W register are XOR'ed with the eight-bit lit- eral 'k'. The result is placed in the W register.				

14.8 MPLAB ICD In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD, is a powerful, low cost, run-time development tool. This tool is based on the FLASH PIC16F87X and can be used to develop for this and other PIC microcontrollers from the PIC16CXXX family. The MPLAB ICD utilizes the in-circuit debugging capability built into the PIC16F87X. This feature, along with Microchip's In-Circuit Serial Programming[™] protocol, offers cost-effective in-circuit FLASH debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by watching variables, single-stepping and setting break points. Running at full speed enables testing hardware in real-time.

14.9 PRO MATE II Universal Device Programmer

The PRO MATE II universal device programmer is a full-featured programmer, capable of operating in stand-alone mode, as well as PC-hosted mode. The PRO MATE II device programmer is CE compliant.

The PRO MATE II device programmer has programmable VDD and VPP supplies, which allow it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for instructions and error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In stand-alone mode, the PRO MATE II device programmer can read, verify, or program PIC devices. It can also set code protection in this mode.

14.10 PICSTART Plus Entry Level Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient.

The PICSTART Plus development programmer supports all PIC devices with up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

14.11 PICDEM 1 Low Cost PIC MCU Demonstration Board

The PICDEM 1 demonstration board is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A). PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The user can program the sample microcontrollers provided with the PICDEM 1 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The user can also connect the PICDEM 1 demonstration board to the MPLAB ICE incircuit emulator and download the firmware to the emulator for testing. A prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs connected to PORTB.

14.12 PICDEM 2 Low Cost PIC16CXX Demonstration Board

The PICDEM 2 demonstration board is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 2 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a serial EEPROM to demonstrate usage of the I²C[™] bus and separate headers for connection to an LCD module and a keypad.



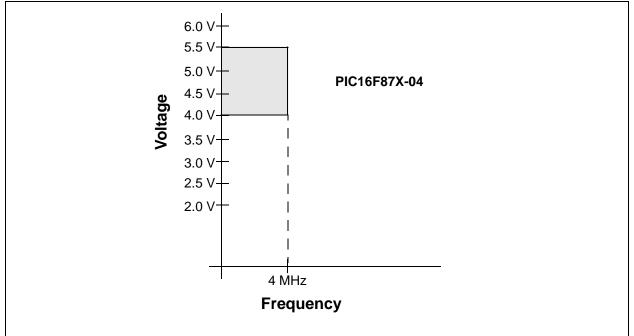
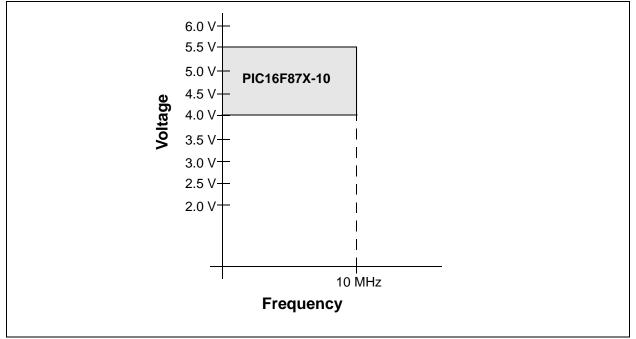


FIGURE 15-4: PIC16F87X-10 VOLTAGE-FREQUENCY GRAPH (EXTENDED TEMPERATURE RANGE ONLY)



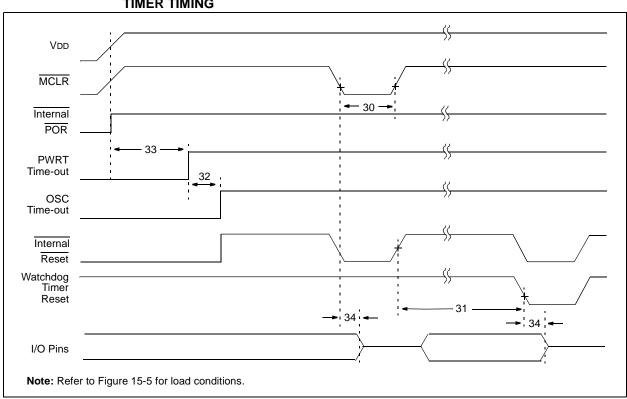


FIGURE 15-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

FIGURE 15-9: BROWN-OUT RESET TIMING

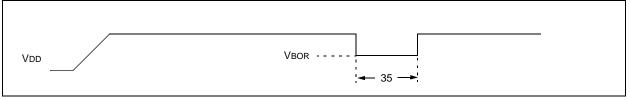


TABLE 15-3:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

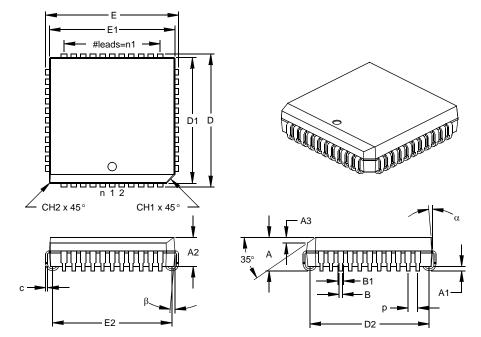
Parameter No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	-		μs	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc	_	—	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +85°C
34	Tıoz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.1	μS	
35	TBOR	Brown-out Reset pulse width	100	_		μs	$VDD \le VBOR (D005)$

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

44-Lead Plastic Leaded Chip Carrier (L) – Square (PLCC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	INCHES*		MILLIMETERS			
Dimension	n Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		44			44	
Pitch	р		.050			1.27	
Pins per Side	n1		11			11	
Overall Height	А	.165	.173	.180	4.19	4.39	4.57
Molded Package Thickness	A2	.145	.153	.160	3.68	3.87	4.06
Standoff §	A1	.020	.028	.035	0.51	0.71	0.89
Side 1 Chamfer Height	A3	.024	.029	.034	0.61	0.74	0.86
Corner Chamfer 1	CH1	.040	.045	.050	1.02	1.14	1.27
Corner Chamfer (others)	CH2	.000	.005	.010	0.00	0.13	0.25
Overall Width	Е	.685	.690	.695	17.40	17.53	17.65
Overall Length	D	.685	.690	.695	17.40	17.53	17.65
Molded Package Width	E1	.650	.653	.656	16.51	16.59	16.66
Molded Package Length	D1	.650	.653	.656	16.51	16.59	16.66
Footprint Width	E2	.590	.620	.630	14.99	15.75	16.00
Footprint Length	D2	.590	.620	.630	14.99	15.75	16.00
Lead Thickness	С	.008	.011	.013	0.20	0.27	0.33
Upper Lead Width	B1	.026	.029	.032	0.66	0.74	0.81
Lower Lead Width	В	.013	.020	.021	0.33	0.51	0.53
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MO-047

Drawing No. C04-048

INDEX

Α

A/D
Acquisition Requirements
ADCON0 Register
ADCON1 Register
ADIF bit
Analog Input Model Block Diagram
Analog Port Pins
Associated Registers and Bits
Block Diagram
Calculating Acquisition Time114
Configuring Analog Port Pins
Configuring the Interrupt
Configuring the Module113
Conversion Clock
Conversions
Delays
Effects of a RESET117
GO/DONE bit
Internal Sampling Switch (Rss) Impedence
Operation During SLEEP
Result Registers
Sampling Requirements
Source Impedence
Time Delays114
Absolute Maximum Ratings
ACK
Acknowledge Data bit
Acknowledge Pulse
Acknowledge Sequence Enable bit
Acknowledge Status bit
ADRES Register
Analog Port Pins. See A/D
Analog-to-Digital Converter. See A/D
Application Notes
AN552 (Implementing Wake-up on Key Strokes
Using PIC16CXXX)
AN556 (Implementing a Table Read)
AN578 (Use of the SSP Module in the I2C
Multi-Master Environment)
Architecture
PIC16F873/PIC16F876 Block Diagram5
PIC16F874/PIC16F877 Block Diagram
Assembler
MPASM Assembler143
В
Banking, Data Memory 12, 18
Baud Rate Generator
BCLIF
BF
Block Diagrams
A/D
A/D Converter113

 Analog Input Model
 114

 Baud Rate Generator
 79

 Capture Mode
 59

 Compare Mode
 60

 I²C Master Mode
 78

 I²C Module
 73

 I²C Slave Mode
 73

 Interrupt Logic
 129

 PIC16F873/PIC16F876
 5

PIC16F874/PIC16F877	6
PORTA	
RA3:RA0 and RA5 Pins	
RA4/T0CKI Pin	29
PORTB	
RB3:RB0 Port Pins	
RB7:RB4 Port Pins	31
PORTC	
Peripheral Output Override (RC 0:2, 5:7)	
Peripheral Output Override (RC 3:4)	
PORTD	
PORTD and PORTE (Parallel Slave Port)	
PORTE	36
PWM Mode	61
RESET Circuit	123
SSP (I ² C Mode)	73
SSP (SPI Mode)	
Timer0/WDT Prescaler	47
Timer1	52
Timer2	55
USART Asynchronous Receive	101
USART Asynchronous Receive (9-bit Mode)	103
USART Transmit	99
Watchdog Timer	131
BOR. See Brown-out Reset	
BRG	79
BRGH bit	
Brown-out Reset (BOR) 119, 123, 7	125, 126
BOR Status (BOR Bit)	25
Buffer Full bit, BF	74
Bus Arbitration	89
Bus Collision Section	89
Bus Collision During a Repeated START Condition	92
Bus Collision During a START Condition	
Bus Collision During a STOP Condition	93
Bus Collision Interrupt Flag bit, BCLIF	24

С

Capture/Compare/PWM (CCP)	57
Associated Registers	
Capture, Compare and Timer1	62
PWM and Timer2	63
Capture Mode	59
Block Diagram	59
CCP1CON Register	58
CCP1IF	59
Prescaler	59
CCP Timer Resources	57
CCP1	
RC2/CCP1 Pin	7, 9
CCP2	
RC1/T1OSI/CCP2 Pin	7, 9
Compare	
Special Trigger Output of CCP1	60
Special Trigger Output of CCP2	60
Compare Mode	60
Block Diagram	60
Software Interrupt Mode	
Special Event Trigger	60
Interaction of Two CCP Modules (table)	57